ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES INDUSTRIES INDUSTRIES	C. Bannockb	urn. Illinois. A	ll rights reserved u ntions.	nder both	This docum level parts, t	ent is a declaration en	n of the substan compasses all lo	ces within the manufacture wer level materials for w	rer listed it hich the m	em. Note: if anufacturer	the item is an as has engineering	sembly with lower responsibility.	
	P1.1IPC Web Site for Information on IPC-1752 StandardFohttp://www.ipc.org/IPC-175xDis				be * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials a				ials and M	s and Mfg Information			
Supplier Information													
Company name* Compa			ompany unique ID			Unique ID Authority				Response Date*			
onsemi										2024-05-21			
Contact Name Title - Contact			act			Phone - Contact*			Email - Contact*				
Product-Env-Stewards Product Envi			Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative			presentative			Phone - Representative*			Email - Representative*				
Product-Env-Stewards Produc			roduct Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	Manufacturing Site	V	Weight*	UOM	Unit Type	
	NC7SP1	NC7SP126P5X ULP B		ULP Buffer 3-STATE Output		2024-05-21		PBB		5.842	mg	Each	
Manufacturing Proccess Informati	on		·			·	·	·			· ·	·	
Terminal Plating / Grid Array Mat	erial Terminal Base A		Alloy J-STD-020 MSL Ra		Rating	Peak Process Body Temperature		ature Max Time at Peak	Temperat	ure Numb	er of Reflow Cy	les	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy	1	l		260	С	30	secon	ds 3			
Comments													
evel 1 - maximum time at peak temperatur	e during sol	dering is 10-3	0 seconds										
or more information regarding material c	omposition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.147	mg	Supplier	Silicon (Si)	7440-21-3		0.147	mg
Die Attach Epoxy	0.04	mg	Supplier	Silver (Ag)	7440-22-4		0.0368	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0032	mg
Lead Frame	2.213	mg	Supplier	Silver (Ag)	7440-22-4		0.0066	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0027	mg
			Supplier	Iron (Fe)	7439-89-6		0.052	mg
			Supplier	Copper (Cu)	7440-50-8		2.151	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0007	mg
Mold Compound-Black	3.182	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.9228	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0318	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		2.2274	mg
Plating	0.23	mg	Supplier	Tin (Sn)	7440-31-5		0.23	mg
Wire Bond - Au	0.03	mg	Supplier	Gold (Au)	7440-57-5		0.03	mg